

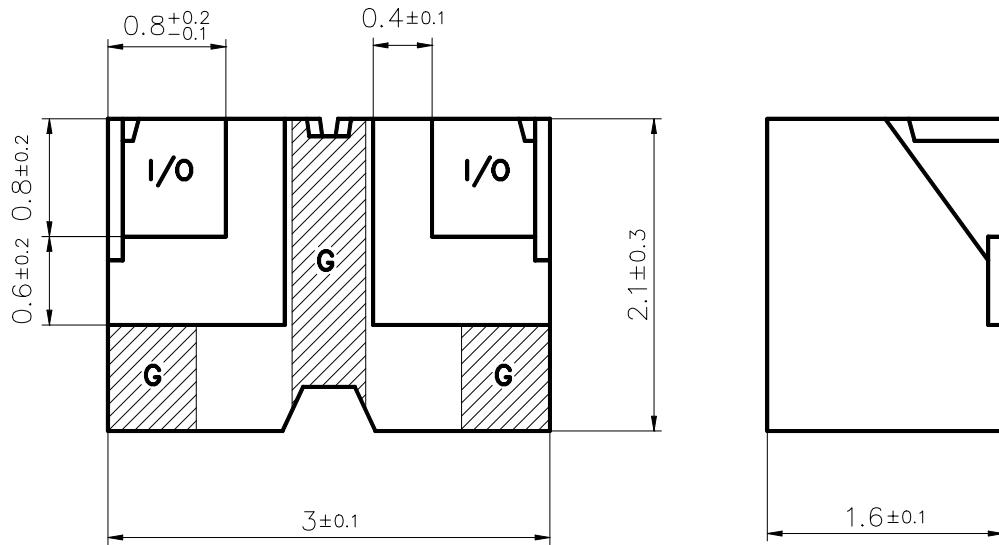
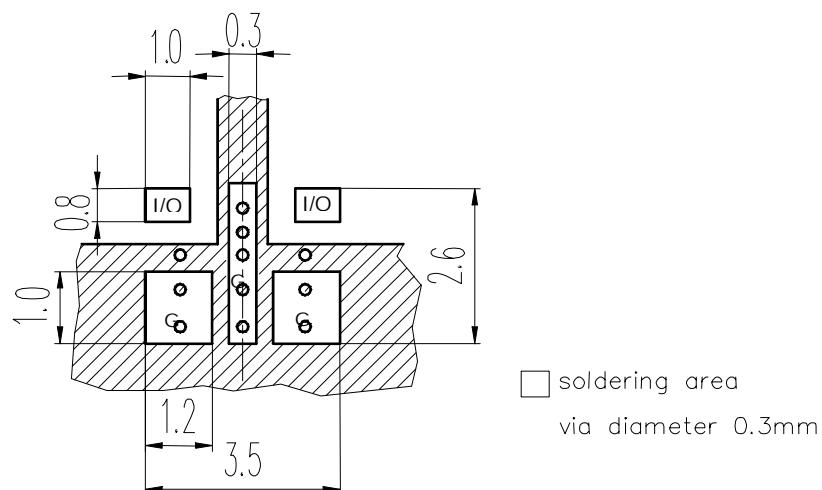
Features

- SMD filter consisting of coupled resonators with stepped impedances
- $\text{MgTiO}_3 - \text{CaTiO}_3$ ($\epsilon_r = 21$ / $T\text{C}_f = 0 \pm 10 \text{ ppm/K}$) with a coating of copper ($10 \mu\text{m}$) and tin ($> 5 \mu\text{m}$)
- Excellent reflow solderability, no migration effect due to copper/tin metallization

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Component drawing

Recommended footprint


FOOTPRINT_010601.DWG→WMF

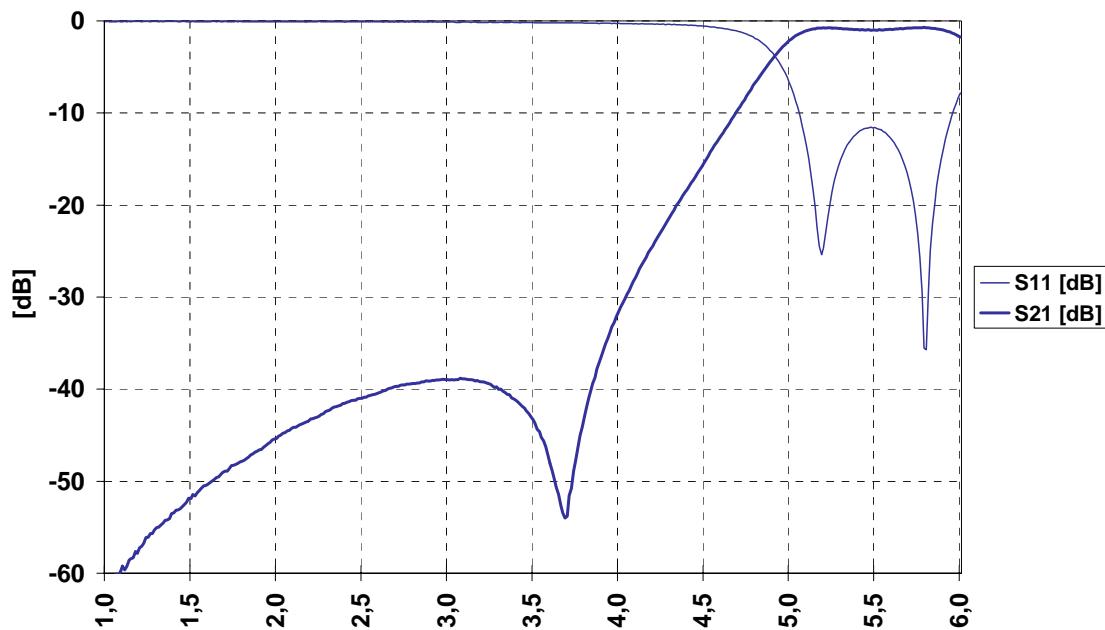
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Characteristics

		min.	typ.	max.	
Center frequency	f_c			5.5	GHz
Insertion loss [5150 – 5850] MHz	α_{IL}		1.0	1.4	dB
Passband [5150 – 5850] MHz	B	700			MHz
Amplitude ripple (peak - peak) [5150 – 5850] MHz	$\Delta\alpha$				dB
Standing wave ratio [5150 – 5850] MHz	SWR		1.8	2.0	
Impedance	Z		50		Ω
Power	P			1.0	W
Attenuation	α				
at DC to 1990 MHz		45	50		dB
at 1990 to 2170 MHz		42	45		dB
at 2400 to 2500 MHz		40	43		dB

Maximum ratings

IEC climatic category (IEC 68-1)	- 40/+ 90/56	
Operating temperature	T_{op} -40 / +85	°C

Typical passband characteristic


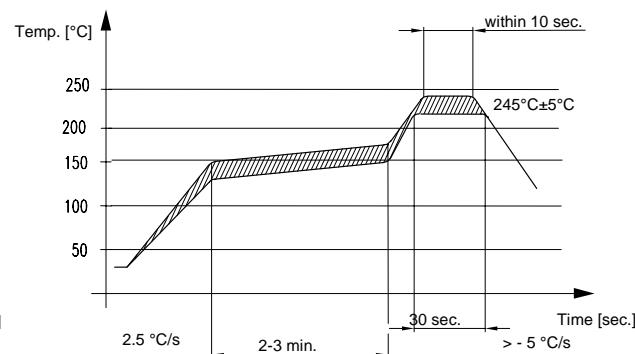
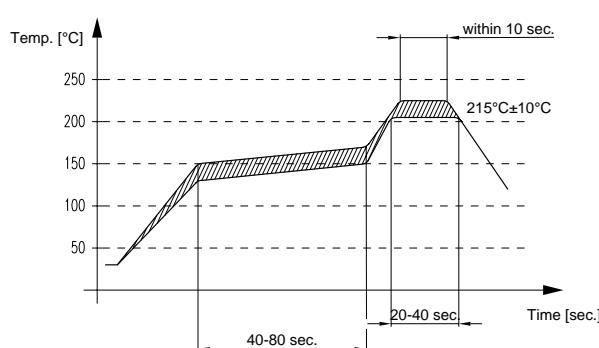
Preliminary Datasheet
Processing information

ZNr.: 577 (FILT95_2)

- Wettability to IEC 68-2-58: $\geq 75\%$ (after aging)

Soldering requirements

	Profile for eutectic SnPb solder paste	Profile for leadfree solder paste	
Soldering type	reflow	reflow	
Maximum soldering temperature (measuring point on top surface of the component)	235 (max. 2 sec.) 225 (max. 10 sec.)	260 (max. 2 sec.) 250 (max. 10 sec.)	°C °C

Recommended soldering conditions (infrared):

Delivery mode

- Blister tape acc. to IEC 286-3, PS, grey
- Pieces/tape: t.b.d.

t.b.d.

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The information contained in this data sheet describes the type of component and shall not be considered as guaranteed characteristics. Purchase orders are subject to the General Conditions for the Supply of Products and Services of the Electrical and Electronics Industry recommended by the ZVEI (German Electrical and Electronic Manufacturers' Association), unless otherwise agreed.

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